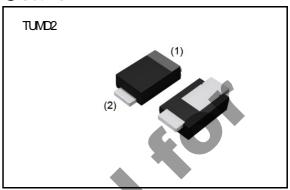


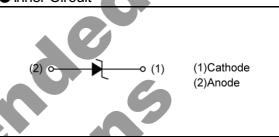
Data sheet Zener Diode

|--|

Outline



Feature High reliability Small mold type Inner Circuit



Application Voltage regulation

	● Packaging Specification			
	Packing	Embossed Tape		
	Reel Size(mm)	180		
	Taping Width(mm)	8		
	Basic Ordering Unit(pcs)	3000		
	Taping Code	TR		
	Marking	65		
.5°C)				
Svmbol	Limits	Unit		

Structure Silicon Epitaxial Planar

● Absolute Maximum Rating (T<sub>a</sub> = 25°C)

Parameter	Symbol	Limits	Unit
Pow er dissipation	$P_{D}$	500	mW
Junction temperature	Ţ	150	°C
Storage temperature	T <sub>stg</sub>	-55 <b>~</b> 150	°C

# ● Electrical Characteristic (T<sub>a</sub> = 25°C)

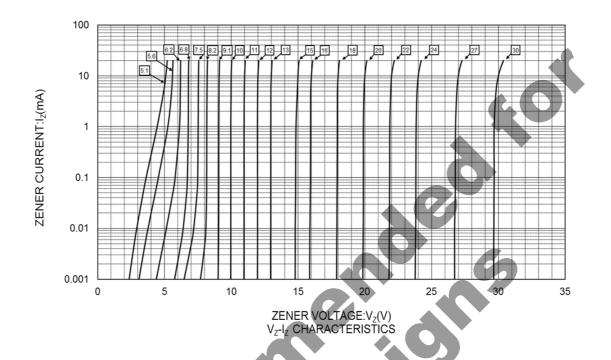
Symbol					
P/N	Ze	ener Voltage:V <sub>Z</sub> (	Reverse Current:I <sub>R</sub> (µA)		
	MIN.	MAX.	I <sub>Z</sub> (mA)	MAX.	V <sub>R</sub> (V)
TDZ 5.1	4.600	5.600	10.0	10.0	1.5
TDZ 5.6	5.100	6.100	10.0	10.0	2.5
TDZ 6.2	5.600	6.800	10.0	10.0	3.0
TDZ 6.8	6.200	7.400	10.0	10.0	3.5
TDZ 7.5	6.800	8.300	10.0	10.0	4.5
TDZ 8.2	7.400	9.000	10.0	10.0	4.9
TDZ 9.1	8.200	10.000	10.0	10.0	5.5
TDZ 10	9.000	11.00	10.0	10.0	6.0
TDZ 11	9.90	12.10	10.0	10.0	7.0
TDZ 12	10.80	13.20	10.0	10.0	8.0
TDZ 13	11.70	14.30	10.0	10.0	9.0
TDZ 15	13.50	16.50	10.0	10.0	10.0
TDZ 16	14.40	17.60	10.0	10.0	11.0
TDZ 18	16.20	19.80	10.0	10.0	13.0
TDZ 20	18.00	22.00	10.0	10.0	14.0
TDZ 22	19.80	24.20	10.0	10.0	16.0
TDZ 24	21.60	26.40	10.0	10.0	17.0
TDZ 27	24.30	29.70	10.0	10.0	19.0
TDZ 30	27.00	33.00	10.0	10.0	21.0

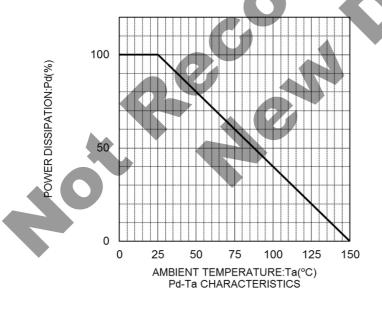
V<sub>7</sub> test time is 40ms

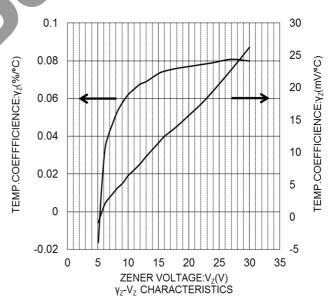
## Marking

P/N	Marking	P/N	Marking
TDZ 5.1	A2	TDZ 13	35
TDZ 5.6	(2	TDZ 15	45
TDZ 6.2	E2	TDZ 16	55
TDZ 6.8	F2	TDZ 18	65
TDZ 7.5	H2	TDZ 20	75
TDZ 8.2	J2	TDZ 22	85
TDZ 9.1	L2	TDZ 24	95
TDZ 10	05	TDZ 27	A5
TDZ 11	. 15	TDZ 30	ප
TDZ 12	25		

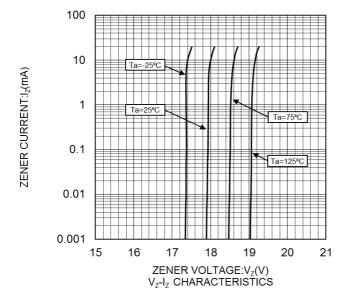
## Electrical Characteristic Curves

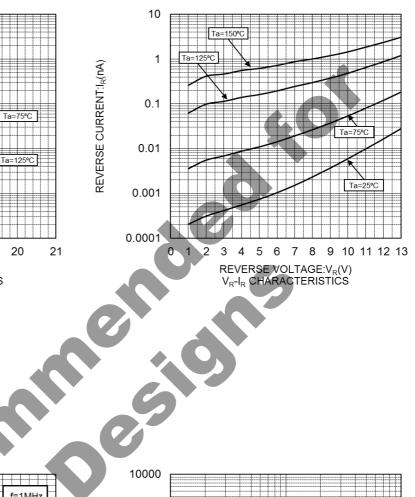


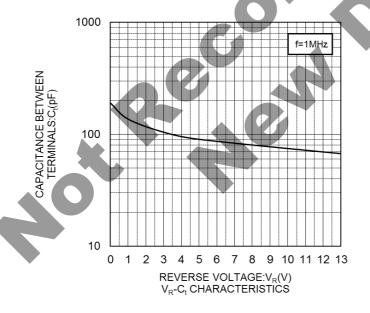


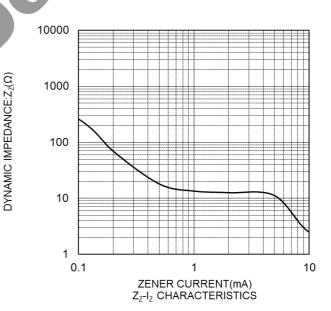


## Electrical Characteristic Curves

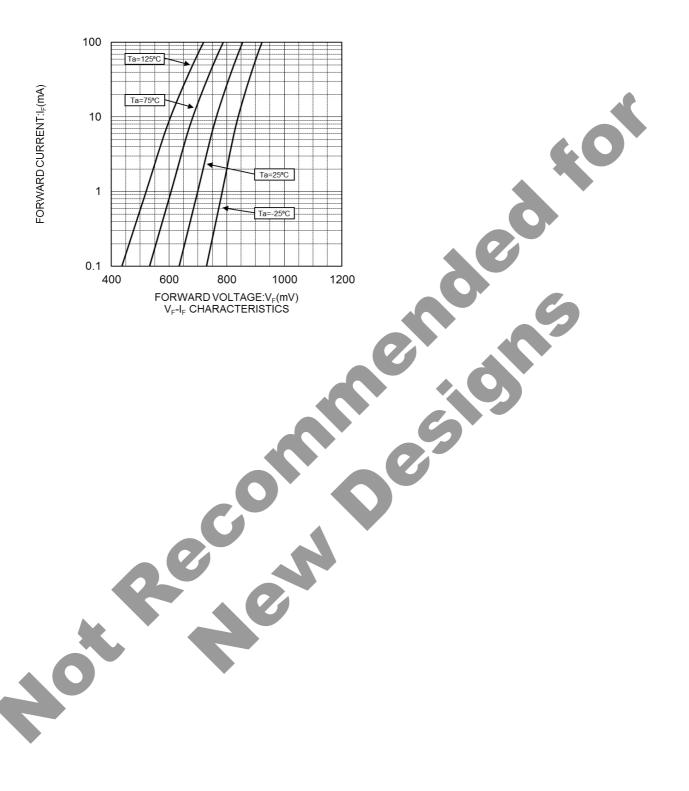






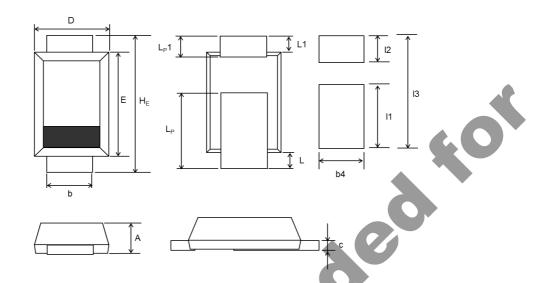


## Electrical Characteristic Curves

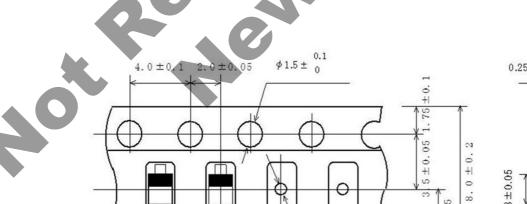


■ Taping

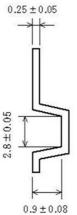
## ● Dimension (TUMD2)



DIM		Milimeters			Inches	
DIIVI	Min.	Average	Max.	Min.	Average	Max.
А	0.50	0.60	0.80	0.020	0.024	0.031
b	0.75	0.80	0.85	0.029	0.031	0.033
С	0.12	0.17	0.27	0.005	0.007	0.011
D	1.25	1.30	1.35	0.049	0.051	0.053
E	1.80	1.90	2.00	0.071	0.075	0.079
HE	2.30	2.50	2.70	0.090	0.098	0.106
L	-	0.30	-	-	0.012	)
L1	-	0.30	-	-	0.012	D
L <sub>P</sub>	1.35	1.45	1.55	0.053	0.057	0.061
L <sub>P</sub> 1	0.30	0.40	0.50	0.012	0.016	0.020
b4	-/	1.10	-		0.043	-
I1	1	2.00	-		0.079	-
12		0.80			0.031	-
13		3.30	4-0		0.130	-



4.0  $\pm$  0.1



 $1.53\pm0.03$ 

 $\phi 1 \pm {0.2 \atop 0}$ 

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLACCIT	
CLASSIV	CLASSIII	CLASSⅢ	CLASSII	

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

## **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

## **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

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